PXIe-4147 Specifications





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PXIe-4147 Specifications

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.
- **Measured** specifications describe the measured performance of a representative model.

Specifications are **Warranted** unless otherwise noted.

Conditions

Specifications are valid under the following conditions unless otherwise noted.

- Ambient temperature^[1] of 23 °C ± 5 °C
- Relative humidity between 10% and 70%, noncondensing. See <u>Programming and Measurement Accuracy/Resolution</u> for additional performance derating when operating above 70% relative humidity.
- Chassis with slot cooling capacity ≥38 W^[2]
 - For chassis with slot cooling capacity = 38 W, fan speed set to HIGH
- Calibration interval of 1 year
- 30 minutes warm-up time
- Self-calibration performed within the last 24 hours

 niDCPower Aperture Time property or NIDCPOWER_ATTR_APERTURE_TIME attribute set to 2 power-line cycles (PLC)

Block Diagrams

Figure 1. PXIe-4147 Block Diagram

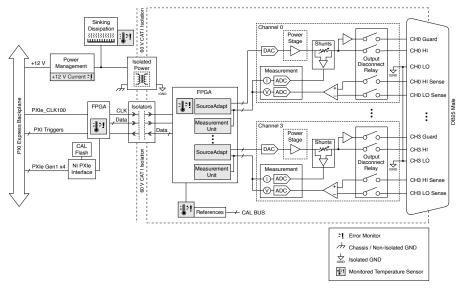
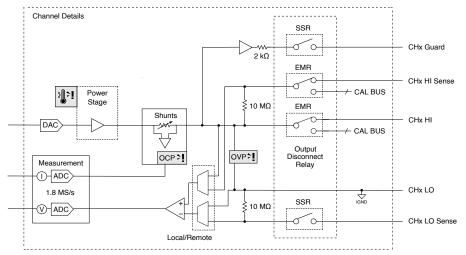
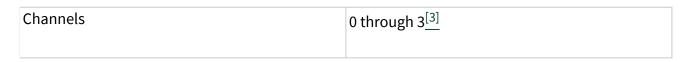


Figure 2. Channel-Level Block Diagram



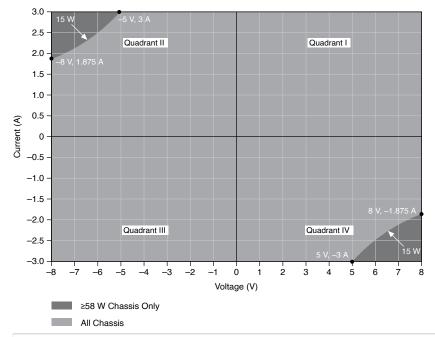
Instrument Capabilities



| DC voltage ranges | 1 V, 8 V |
|-------------------|---|
| DC current ranges | 1 μΑ, 10 μΑ, 100 μΑ, 1 mΑ, 10 mΑ, 100 mΑ, 3 Α |

The following figure illustrates the voltage and the current source and sink ranges of the PXIe-4147.

Figure 1. PXIe-4147 Quadrant Diagram, Any Channel



| Sourcing ^[5] | | | |
|--|---------------------------------|--|--|
| All chassis | 24 W per channel and 40 W total | | |
| Sinking | | | |
| ≥58 W Slot Cooling Capacity Chassis[6] | 24 W per channel and 40 W total | | |
| <58 W Slot Cooling Capacity Chassis | 15 W per channel and 15 W total | | |

Voltage

Table 1. Voltage Programming and Measurement Accuracy/Resolution

| Range | Resolution (Noise Limited) Noise (0.1 Hz to 10 Hz, peak- to-peak, typical) | | | Tempco ^[8] ± (% of Voltage + Offset)/°C | |
|-------|--|--|--|--|---|
| | | T _{ambient} 23 °C±5 °C, T _{cal} [9]±5 °C | | | |
| | | | Multiple Channels <mark>[10]</mark> | Single Channel <u>^[11]</u> | T _{ambient} 0 °C to 55 °C, T _{cal} ±5 °C |
| 1 V | 100 nV | 2 μV | $0.025\% + 110 \mu$ V | /0.02% + 70 μV | $0.0002\% + 1 \mu V$ |
| 8 V | 1 µV | 12 μV | $0.02\% + 600~\mu\text{V}$ | 0.015% + 400 μV | / |

Current

Table 2. Current Programming and Measurement Accuracy/Resolution

| Range | Resolution (Noise Limited) | ted) Noise (0.1 Hz to 10 Hz, peak- to-peak, typical) | Accuracy ± (% o Offset) ^[12] | f Current + | Tempco ^[13] ± (% of Current + Offset)/°C |
|--------|-------------------------------|---|--|--------------------------------|---|
| | typical) | | T _{ambient} 23 °C±5 | °C, T _{cal} [14]±5 °C | T _{ambient} 0 °C to |
| | | Multiple Channels ^[15] | Single Channel | 55 °C, T _{cal} ±5 °C | |
| 1 μA | 100 fA | 8 pA | 0.045% + 250 pA | \0.035% + 150 pA | 0.0003% + 2 pA |
| 10 µA | 1 pA | 60 pA | 0.05% + 1.6 nA | 0.035% + 1 nA | |
| 100 µA | 10 pA | 400 pA | 0.045% + 14 nA | 0.035% + 8 nA | |
| 1 mA | 100 pA | 4 nA | 0.04% + 120 nA | 0.03% + 70 nA | |
| 10 mA | 1 nA | 40 nA | 0.04% + 1.2 μA | 0.03% + 700 nA | |
| 100 mA | 10 nA | 400 nA | $0.045\% + 12 \mu\text{A}$ | 0.035% + 7 μA | |
| 3 A | 1 μA | 40 μΑ | 0.07% + 800 μA | 0.07% + 400 μA | |

Noise

| Wideband source noise ^[17] | <10 mV _{pk-pk} , typical |
|---------------------------------------|-----------------------------------|
| | |

The following figures illustrate measurement noise as a function of measurement aperture for the PXIe-4147.

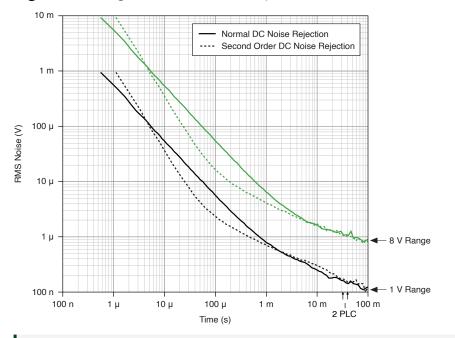


Figure 1. Voltage RMS Noise Versus Aperture Time, Nominal

Note When the aperture time is set to two power-line cycles (PLCs), measurement noise differs slightly depending on whether the niDCPower Power Line Frequency property or NIDCPOWER_ATTR_POWER_LINE_FREQUENCY attribute is set to 50 Hz or 60 Hz.

Note To configure normal or second-order DC noise rejection, set the niDCPower DC Noise Rejection property or NIDCPOWER_ATTR_DC_NOISE_REJECTION attribute.

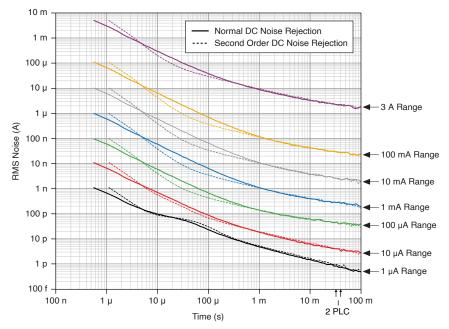


Figure 1. Current RMS Noise Versus Aperture Time, Nominal

Note When the aperture time is set to two power-line cycles (PLCs), measurement noise differs slightly depending on whether the niDCPower Power Line Frequency property or NIDCPOWER_ATTR_POWER_LINE_FREQUENCY attribute is set to 50 Hz or 60 Hz.

Note To configure normal or second-order DC noise rejection, set the niDCPower DC Noise Rejection property or NIDCPOWER_ATTR_DC_NOISE_REJECTION attribute.

Transient Response and Settling Time

| Settling time ^[18] | | |
|--|-----------------|--|
| Voltage mode, ≤4 V step, unloaded ^[19] | <50 μs, typical | |
| Current mode, full-scale step, 3 A to 100 μ A ranges ^[20] | <50 μs, typical | |

| Current mode, full-scale step, 10 μ A range ^[20] | <100 μs, typical | | |
|---|------------------|--|--|
| Current mode, full-scale step, 1 μA range ^[20] | <200 μs, typical | | |
| Transient response ^[21] | | | |
| 3 A to 100 μA ranges | <40 μs, typical | | |
| 10 μA range | <100 μs, typical | | |
| 1 μA range | <200 μs, typical | | |

Remote Sense

| Voltage accuracy | Add (10 ppm of voltage range + 25 μV) per volt of LO lead drop, plus 10 μV per volt of HI lead drop to voltage accuracy specification |
|-------------------------------|---|
| Maximum sense lead resistance | 100 Ω |
| Maximum lead drop per lead | 1 V, maximum 8 V between HI and LO terminals |

Load Regulation

| Voltage, local sense ^[22] | 100 μV/mA, nominal; 200 μV/mA, maximum |
|--------------------------------------|--|
| Voltage, remote sense | Error included in accuracy specifications. |
| Current | Error included in accuracy specifications. |

Isolation

| Isolation voltage, any pin to earth ground ^[23] | 60 V DC, CAT I |
|--|---------------------|
| Withstand voltage | 800 V _{pk} |

Protection

| Absolute maximum voltage to Output LO, all pins | | |
|---|---|--|
| Output HI | ±10 V | |
| All other pins | ±60 V | |
| Output channel protection | | |
| Overcurrent or overvoltage | Automatic shutdown, output disconnect relay opens | |
| Overtemperature | Automatic shutdown, output disconnect relay opens | |

Guard Output Characteristics

| Cable guard | |
|------------------|---------------|
| Output impedance | 2 kΩ, nominal |
| Offset voltage | 1 mV, typical |

Output Resistance Programming Accuracy

| Current Level/ | | | Current Mode | |
|----------------|----------------------------------|---|--------------------------------------|--|
| Limit Range | Programmable Resistance Range | Accuracy, ±(% of Resistance Setting + Offset) ^[24] | Programmable Resistance Range | Accuracy, ±(% of resistance setting Offset) ^[24] |
| 1 μΑ | 0 to ±4 MΩ | 0.05% + 100 Ω | ±2.5 MΩ to ±infinity | 0.05% 100 GΩ |
| 10 μΑ | 0 to ±400 kΩ | 0.05% + 10 Ω | ±250 kΩ to ±infinity | 0.05% 10 GΩ |
| 100 µA | 0 to ±40 kΩ | 0.05% + 1 Ω | $\pm 25 \ k\Omega$ to $\pm infinity$ | 0.05% 1 GΩ |
| 1 mA | 0 to ±4 kΩ | 0.05% + 100 mΩ | ±2.5 kΩ to ±infinity | 0.05% 100 ΜΩ |
| 10 mA | 0 to ±400 Ω | 0.05% + 10 mΩ | $\pm 250 \Omega$ to $\pm infinity$ | 0.05% 10 ΜΩ |
| 100 mA | 0 to ±40 Ω | 0.05% + 1 mΩ | $\pm 25 \Omega$ to $\pm infinity$ | 0.05% 1 ΜΩ |
| 3 A | 0 to ±1.25 Ω | 0.08% + 100 μΩ | ±750 mΩ to ±infinity | 0.08% 10 kΩ |

Table 3. Output Resistance Programming Accuracy

Measurement and Update Timing

| Available sample rates ^[25] | (1.8 MS/s)/N, nominal |
|---|---|
| where N = 1, 2, 3, 2²⁴ S is samples | |
| Sample rate accuracy | Equal to PXIe_CLK100 accuracy, nominal |
| Maximum measure rate to host | 1.8 MS/s per channel, continuous, nominal |

| Maximum source update rate ^[26] | 100,000 updates/s, nominal |
|--|---------------------------------|
| Input trigger to | |
| Source event delay | 10 μs, nominal |
| Source event jitter | 2 μs _{pk-pk} , nominal |
| Measure event jitter | 2 μs _{pk-pk} , nominal |

Triggers

| Input triggers | | |
|---|--------------------------------|--|
| Туреѕ | Start | |
| | Source | |
| | Sequence Advance | |
| | Measure | |
| Sources (PXI trigger lines 0 to 7) ^[27] | | |
| Polarity | Active high (not configurable) | |
| Minimum pulse width | 100 ns | |
| Destinations ^[28] (PXI trigger lines 0 to 7) ^[27] | | |
| Polarity | Active high (not configurable) | |
| Minimum pulse width | >200 ns | |
| Output triggers (events) | | |
| Types | Source Complete | |

| | Sequence Iteration Complete | |
|---|--------------------------------|--|
| | Sequence Engine Done | |
| | Measure Complete | |
| Destinations (PXI trigger lines 0 to 7) ^[27] | | |
| Polarity | Active high (not configurable) | |
| Pulse width | 230 ns | |

Physical

| Dimensions | 3U, one-slot, PXI Express/CompactPCI Express module 2.0 cm × 13.0 cm × 21.6 cm (0.8 in. × 5.1 in. × 8.5 in.) | |
|------------------------|---|--|
| Weight | | |
| 20 W | 448 g (15.8 oz) | |
| 40 W | 428 g (15.1 oz) | |
| Front panel connectors | 25-position D-SUB, male | |

Calibration Interval

| Recommended calibration interval | 1 year |
|----------------------------------|--------|
| | |

Power Requirements

| +3.3 V | 1 A, typical |
|--------|---|
| +12 V | 1.3 A, typical at idle; 6 A, maximum at full load |

Environmental Characteristics

Temperature and Humidity

| Temperature | |
|------------------|--|
| Operating | 0 °C to 55 °C [29] |
| Storage | -40 °C to 71 °C |
| Humidity | |
| Operating | 10% to 90%, noncondensing ^[30] |
| Storage | 5% to 95%, noncondensing |
| Pollution Degree | 2 |
| Maximum altitude | 2,000 m (800 mbar) (at 25 °C ambient temperature |

¹ The ambient temperature of a PXI system is defined as the temperature at the chassis fan inlet (air intake).

 2 For increased capability, NI recommends installing the PXIe-4147 in a chassis with slot cooling capacity \geq 58 W.

³ Channels isolated from earth ground, but share a common LO for all channels (bank isolation).

⁴ Power limit defined by voltage measured between HI and LO terminals.

⁵ Sourcing power may be limited by total power available from the chassis power supply. Refer to the <u>Performing a Power Budget on a PXI/PXIe System</u> article for more information.

 $\frac{6}{2}$ When sinking more than 15 W into the PXIe-4147, transients may not exceed 200 mW/µs.

⁷ Refer to the <u>Remote Sense</u> and <u>Load Regulation</u> sections for additional accuracy derating and conditions.

 8 Temperature coefficient applies beyond 23 °C±5 °C ambient within ±5 °C of T_{cal}.

 ${}^9_{-}$ T_{cal} is the internal device temperature recorded by the PXIe-4147 at the completion of the last self-calibration.

¹⁰ Multiple-channel specifications apply whenever two or more channels are connected and sourcing/sinking current. Multiple-channel specifications account for interactions between the channels when operated at high current, including board heating.

¹¹ Single-channel specifications assume only one channel is connected and sourcing/sinking current which results in improved accuracy due to the reduction of effects between the channels, including board heating. When transitioning from a multiple-channel configuration to a single-channel configuration, a ten-minute cool down period is required to meet Single Channel accuracy specifications.

¹² Relative humidity between 10% and 70%, noncondensing. When operating above 70% relative humidity, add 30 pA to current accuracy specifications.

 $\frac{13}{13}$ Temperature coefficient applies beyond 23 °C±5 °C ambient within ±5 °C of T_{cal}.

 $\frac{14}{2}$ T_{cal} is the internal device temperature recorded by the PXIe-4147 at the completion of the last self-calibration.

 $\frac{15}{15}$ Multiple-channel specifications apply whenever two or more channels are connected and sourcing/sinking current. Multiple-channel specifications account for interactions between the channels when operated at high current, including board heating.

¹⁶ Single-channel specifications assume only one channel is connected and sourcing/sinking current which results in improved accuracy due to the reduction of effects between the channels, including board heating. When transitioning from a multiple-channel configuration to a single-channel configuration, a ten-minute cool down period is required to meet Single Channel accuracy specifications.

 $\frac{17}{10}$ 10 Hz to 20 MHz bandwidth. PXIe-4147 configured for normal transient response.

 $\frac{18}{2}$ Measured as the time to settle to within 0.1% of step amplitude, PXIe-4147 configured for fast transient response.

 $\frac{19}{2}$ Current limit set to \geq 30 μ A and \geq 20% of the selected current limit range.

 $\frac{20}{2}$ Voltage limit set to ≥ 2 V, resistive load set to 1 V/selected current range.

²¹ Time to recover within 10 mV after a load current change from 10% to 90% of range, PXIe-4147 configured for fast transient response.

 $\frac{22}{2}$ At the output terminals of attached TB-414X Screw Terminal Connector Kit.

 $\frac{23}{23}$ Channels isolated from earth ground, but share a common LO for all channels (bank isolation).

 $\frac{24}{2}$ Accuracy is typical and applies within ±5 °C of last self calibration.

²⁵ When source-measuring, both the NI-DCPowerSource Delay and Aperture Time properties affect the sampling rate. When taking a measure record, only the Aperture Time property affects the sampling rate.

²⁶ As the source delay is adjusted or if advanced sequencing is used, maximum source update rates may vary.

 $\frac{27}{2}$ Pulse widths and logic levels are compliant with **PXI Express Hardware Specification Revision 1.0 ECN 1**.

²⁸ Input triggers can come from any source (PXI trigger or software trigger) and be exported to any PXI trigger line. This allows for easier multi-board synchronization regardless of the trigger source.

²⁹ Not all chassis can achieve this ambient temperature range. Refer to PXI chassis specifications to determine the ambient temperature ranges your chassis can achieve.

³⁰ When transitioning a device from a storage or operation environment with relative humidity above 70%, device should be allowed to stabilize in the lower humidity environment for several hours before use. Refer to the PXIe-4147**Programming and Measurement Accuracy/Resolution** specifications for additional performance derating when operating above 70% relative humidity.